



Product Change Notification

110979 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

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Product Change Notification

Change Notification #: 110979 - 00
Change Title: Intel® Desktop Board DH67BL, Media, Boxed and Bulk
PCN 110979-00, Product Material, Product Design
Change to NEC USB 3.0 stepping, iTE PCIe to PCI bridge stepping and BIOS Update
Date of Publication: September 16, 2011

Key Characteristics of the Change:

Product Material and Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Oct 03, 2011
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Description of Change to the Customer:

Intel will implement the following changes:

1. To prevent a potential risk to have material shortage on NEC USB 3.0 the part will be changed from A to the F1 stepping.
2. The iTE PCIe to PCI bridge will be changed from the C version to E Stepping to enhance performance.
3. The BIOS will be updated from BLH6710H.86A.0119 to BLH6710H.86A.0128. To access the release notes or get a copy of the BIOS for evaluation, go to <http://downloadcenter.intel.com>.

Customer Impact of Change and Recommended Action:

It has been observed that the change for the USB3.0 controller and the iTE PCIe to PCI bridge reports a "New device detected" in some operating systems. Microsoft* Windows will display a message and automatically install the necessary drivers; however customers may wish to update their OS image to avoid the message.

It is recommended that customers evaluate the new BIOS to ensure a smooth transition. New board revisions cannot be downgraded to an older BIOS version. These changes have been thoroughly evaluated to ensure that there are no quality or reliability implications to our customers. Intel validation of a new board revision does not include testing with older versions of the BIOS. This change is not expected to cause a change to the Microsoft Windows* operating system's software driver stack.

This change has been thoroughly evaluated to ensure that there are no quality, reliability or functional implications to our customers. Intel is not recommending additional qualification of these changes on platforms received from Intel.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change AA	Post Change AA
BOXDH67BLB3	915087	G10189-209	G10189-210
BLKDH67BLB3	915088	G10189-209	G10189-210

PCN Revision History:

Date of Revision:
September 16, 2011

Revision Number:
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Reason:
Originally Published PCN